

Semiconductor detectors @ LAL

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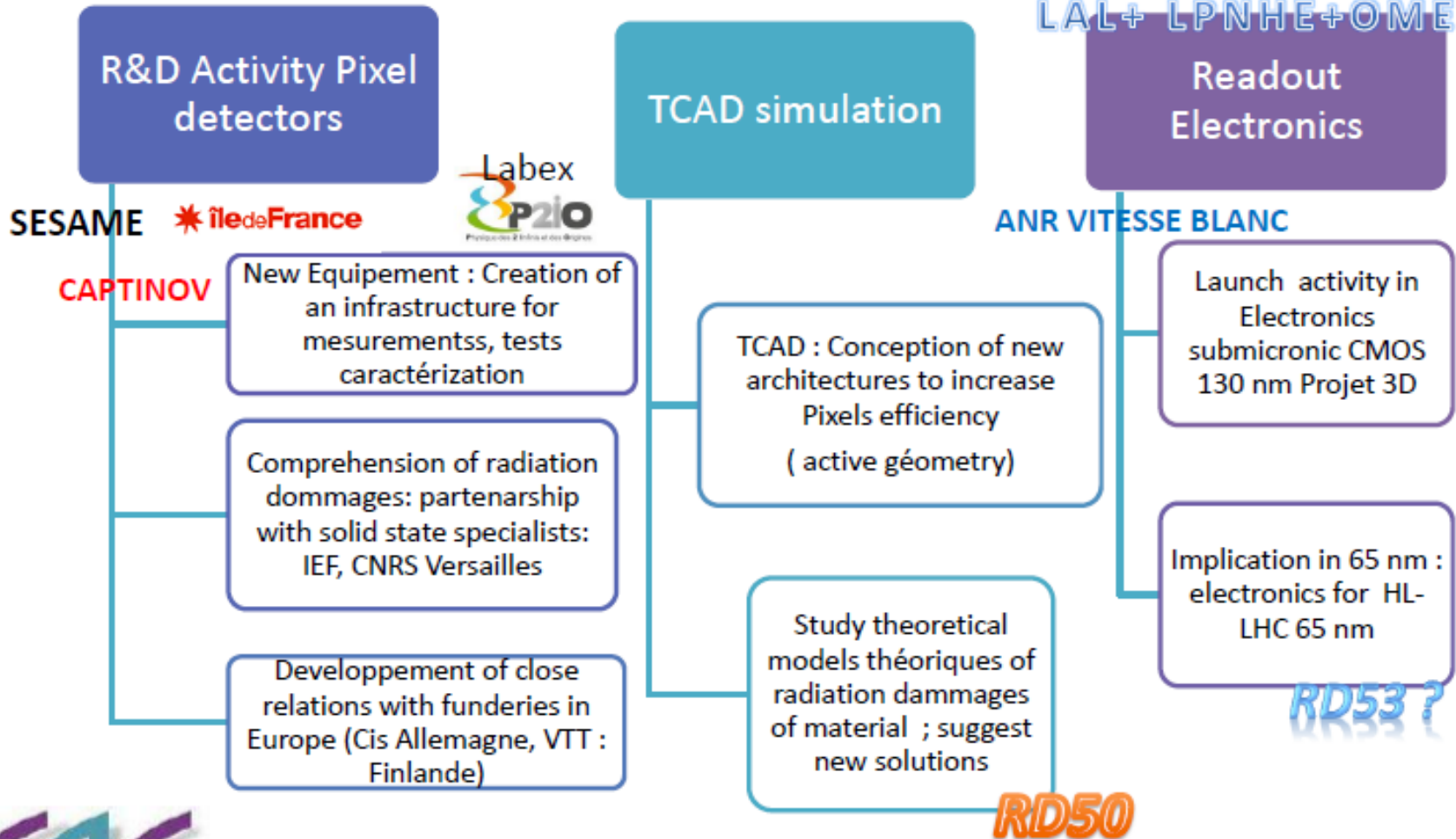
Outline

- Silicon planar pixel sensors
 - High energy physics - ATLAS @ HL-LHC
- Diamond sensors
 - Accelerator physics - ATF2
- Silicon Photomultiplier sensors (SiPM)
 - Tool for semiconductor physics (i.e. avalanche, defects)
 - Applications:
 - Medical imaging
 - High energy physics

summary

R&D ATLAS pixel LAL

LAL+ LPNHE+OMEGA

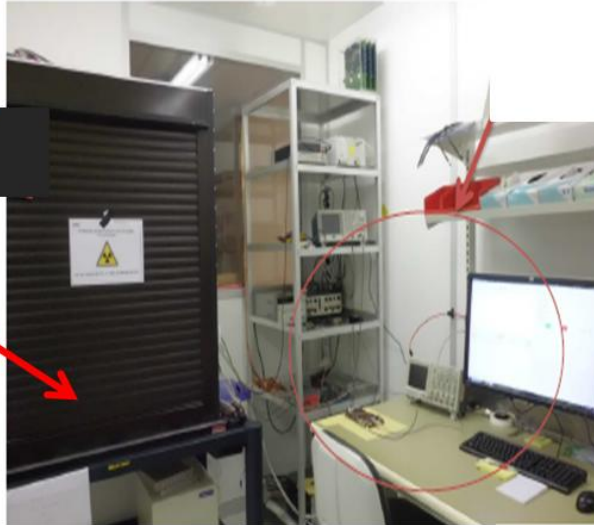
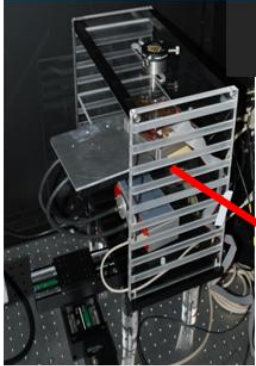


Experimental tools for sensors characterization (1)

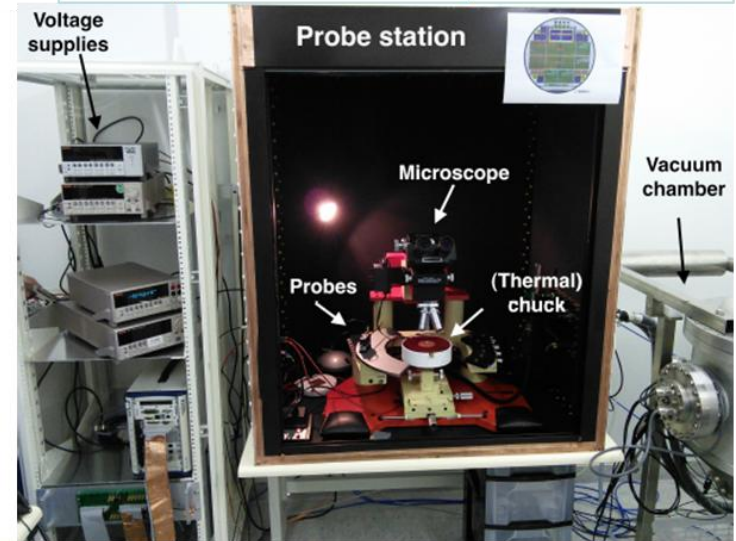
Old ATLAS clean-room – class 100000, 12 m²

Set-up for CCE tests of pixel sensors

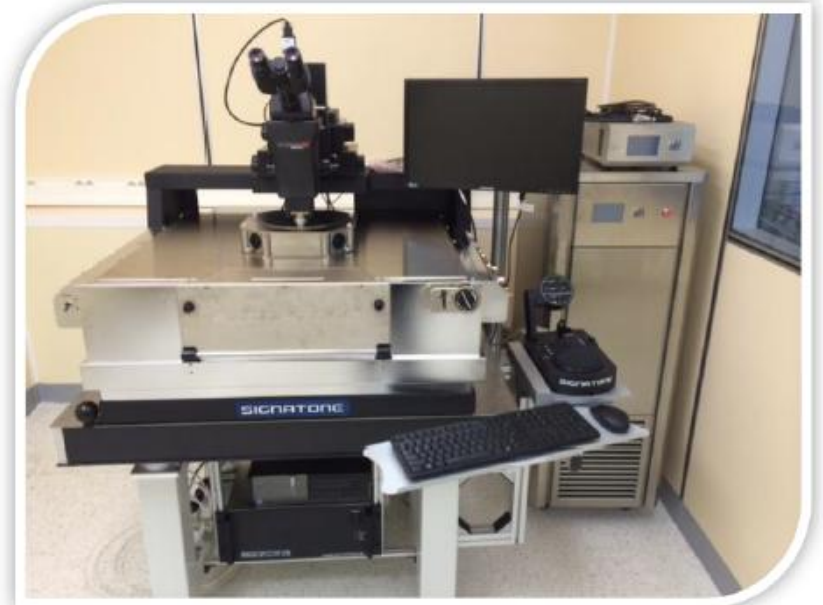
USBPix +
External trigger



Set-up for DC tests of pixel sensors



New clean-room at LAL, class 10000, 100 m²
equipped with a semi-automatic probe-station
(R. Cornat, P2IO – CAPTINOV project)

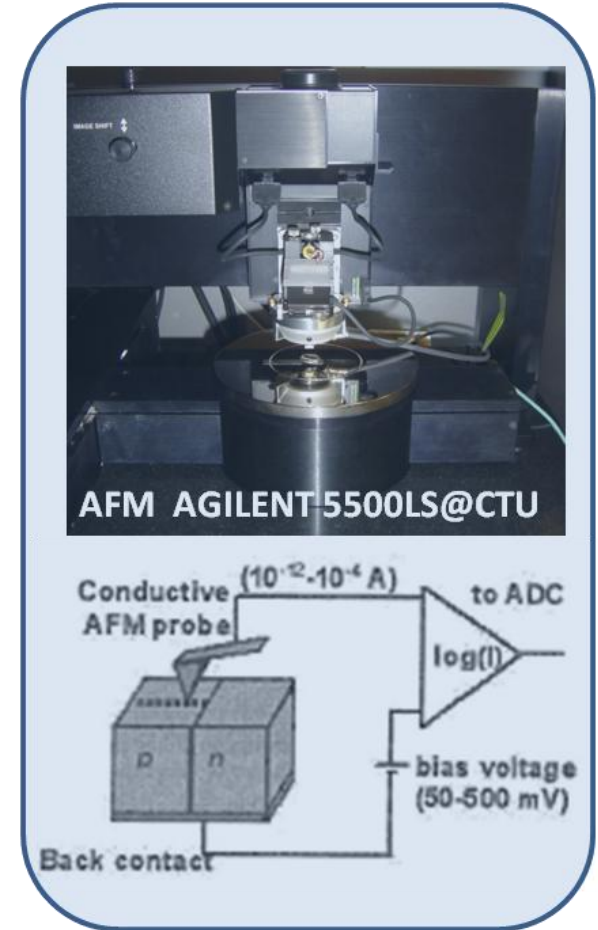


Experimental tools for sensors characterization (2)

Collaborations with GEMAC and CTU-IEF laboratories for doping profiles characterizations



*SIMS at GEMaC laboratory, Versailles
Cameca IMS 7f*



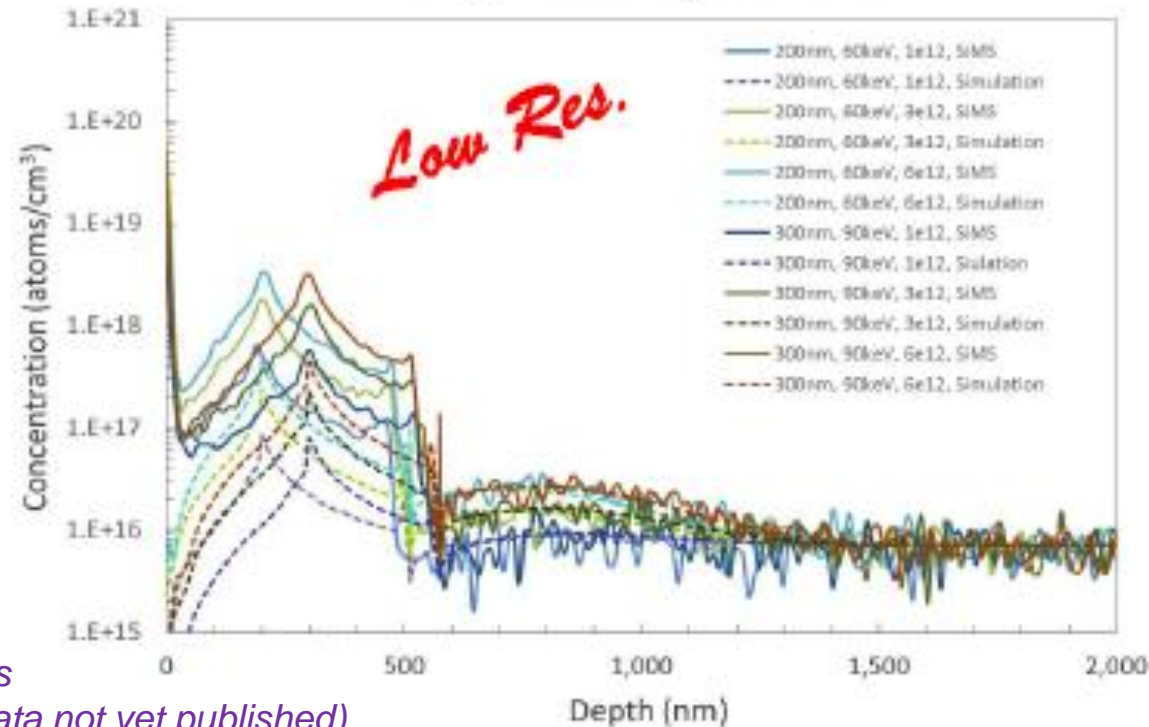
AFM at CTU-Minerve, IEF, Orsay

SYNOPSYS TCAD simulations

Comparison: SIMS measurements/ SYNOPSYS simulations

- very promising results

VTT P-type wafers, Non-Etched



SIMS: N. Dinu, F. Jomard

SYNOPSIS simulations: V. Gkougkousis

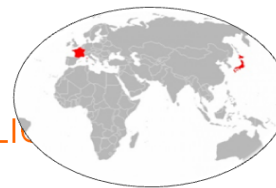
(TIPDOC project, Labex NanoSaclay, data not yet published)

N in P, VTT production, <100> orientation

Oxide thickness	200nm			300nm		
P implantation doses	$1 \times 10^{12} \text{ cm}^{-2}$	$3 \times 10^{12} \text{ cm}^{-2}$	$6 \times 10^{12} \text{ cm}^{-2}$	$1 \times 10^{12} \text{ cm}^{-2}$	$3 \times 10^{12} \text{ cm}^{-2}$	$6 \times 10^{12} \text{ cm}^{-2}$
Implantation energy	60 KeV			90 KeV		
Annealing	3hours, 1000 °C					

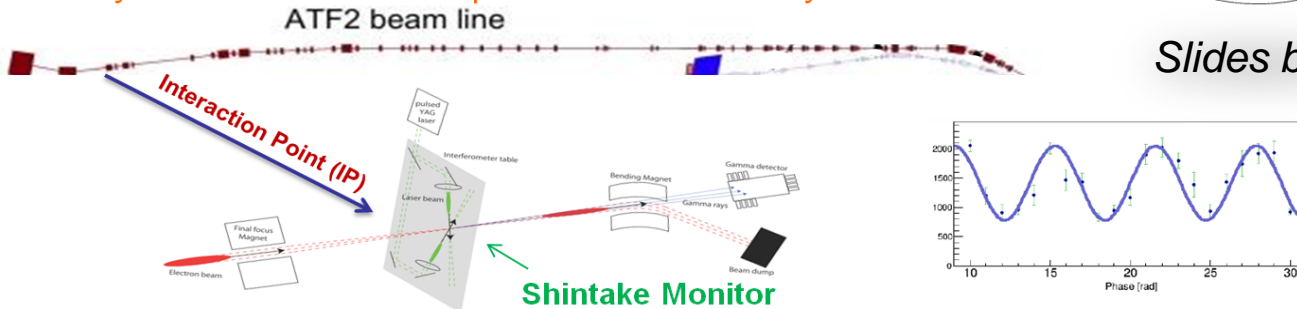
✓ $\rho = 2 \Omega/\text{cm}$ (7×10^{15}) – 380 μm thickness

Accelerator Test Facility (ATF) @ KEK



Low energy (1.3GeV) prototype of the final focus system for ILC and CLIC
 Focus system to validate "compact local chromaticity correction"

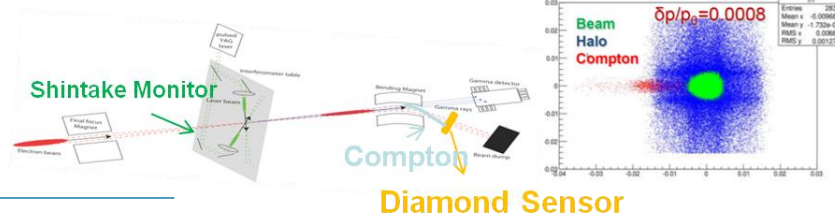
Slides by S. Liu



Goals of ATF2

- goal 1—achieving the 37 nm design vertical beam size at the IP;
- goal 2—stabilizing the beam at that point at the nanometer level;

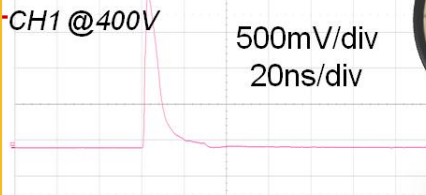
In Vacuum Diamond Sensor



□ Diamond sensor R&D for Beam Halo investigation

- ✓ Tests in the clean room to study the diamond characteristics
- ✓ Tested in air at PHIL from $10^5 \rightarrow 10^8 e^-$
- ✓ Tests to be continued in vacuum
- ✓ Installation at ATF2 for beam halo measurements in Nov. 2014

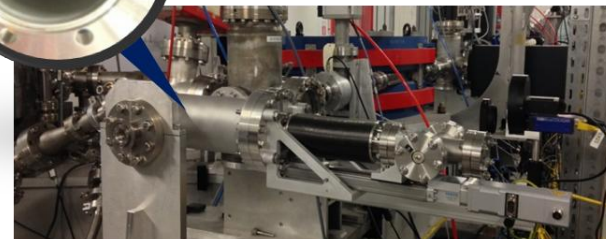
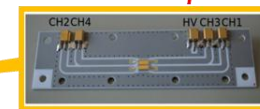
First Test In Vacuum @ PHIL



Tests to be continued before installation @ ATF2 in Nov. 2014

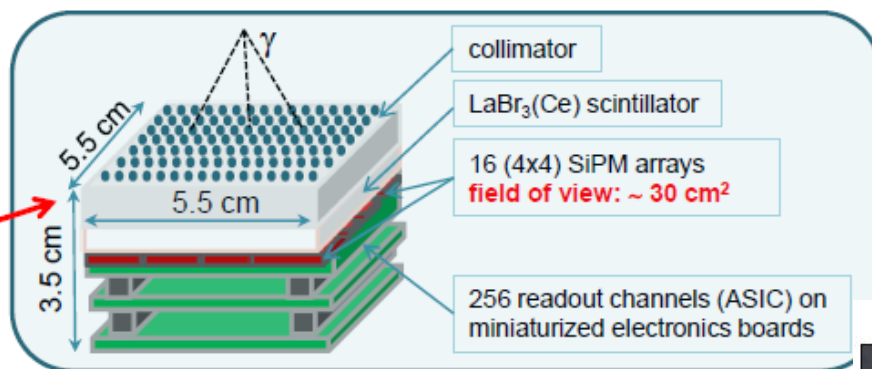
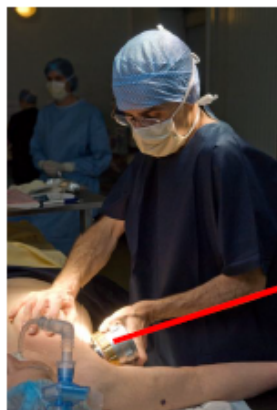


Installed in Sept. 2014



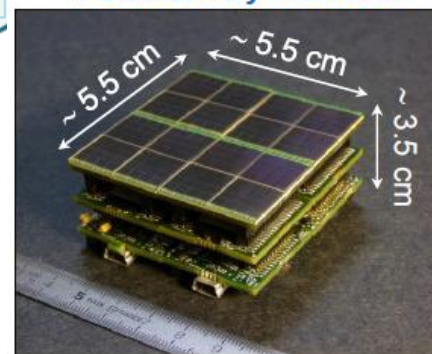
SIPMED project - SiPM for medical imaging

- Miniaturized Gamma Imager for Cancer Surgery (MAGICS)

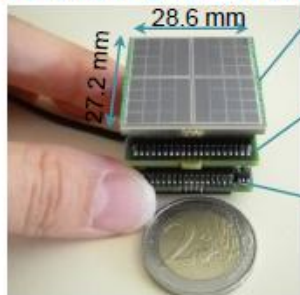


Collaboration IMNC, LAL, Hôpital Lariboisière

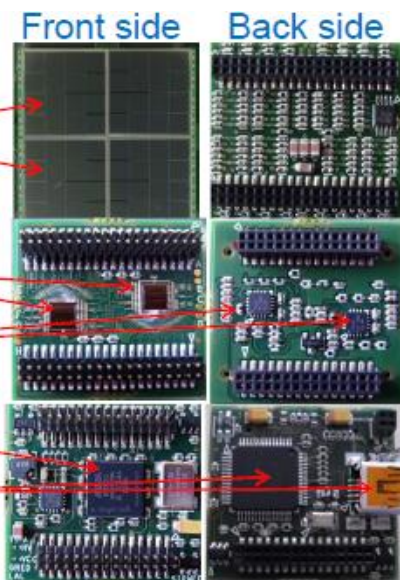
4 elementary modules



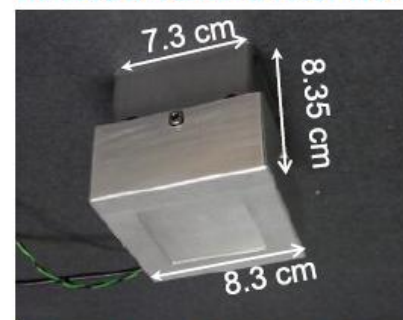
Elementary module
Field of view: ~ 8 cm²



- Board 1:
4 (2x2) SiPM arrays
64 channels
- Board 2:
2 EASIROC chips
64 readout channels
2 ADC 12 bits
- Board 3:
ALTERA cyclone III FPGA
FTDI FT2232H (USB, 2.0 Hi-speed, 440MBit/s)
DC/DC converter for SiPM bias



MAGICS camera final view



Dimensions: 8.3 x 8.3 x 8.35 cm³
Weight: 1.2 kg
Field of view : 5.1x5.1 cm²

T. Ait Imando & al., PhotoDet2012, PoS
N. Dinu & al., NDIP 2014, NIM A

SONIM project under development

- New miniaturized probes for charged particles detection (β^+)

Intra-operative clinical imaging

Miniaturized beta imaging camera for real time guide of cerebral tumors surgery



Collaboration
IMNC, LAL, Hôpital H. Mondor

Pre-clinical studies

Implantable and stand-alone counting probe for neurological studies on small animal



Collaboration LAL, IMNC, CERMEP (Lyon),
Centre de Neurosciences de Paris-Sud

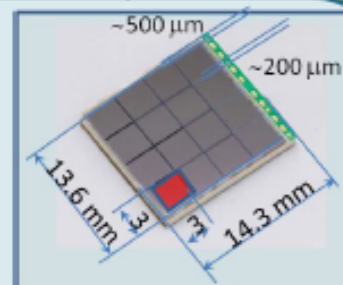
R&D on SiPM detectors (1)

- Requirements for intra-operative β camera for cancer surgery

- arrays of SiPM covering a field of view $\sim 3 \times 3 \text{ cm}^2$ (8x8 SiPM's)
- reduced dead area
- low noise (DCR, afterpulses)
- low T dependence

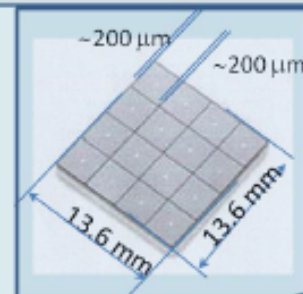
Old HPK SiPM arrays

- monolithic
- wire bonding
- 3-sides buttable



New HPK SiPM arrays

- single SiPM
- TSV technology
- 4-sides buttable



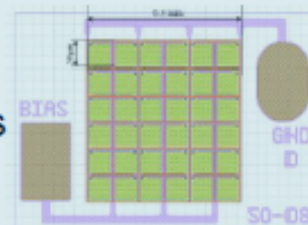
- Requirements for β counting probe in preclinical imaging

- small SiPM ($< 1 \times 1 \text{ mm}^2$)
- low bias voltage ($< 30 \text{ V}$)
- low noise
- low T dependence

16 Ketek SiPM received
 $\bullet 0.3 \times 0.3 \text{ mm}^2$

New Ketek SiPM

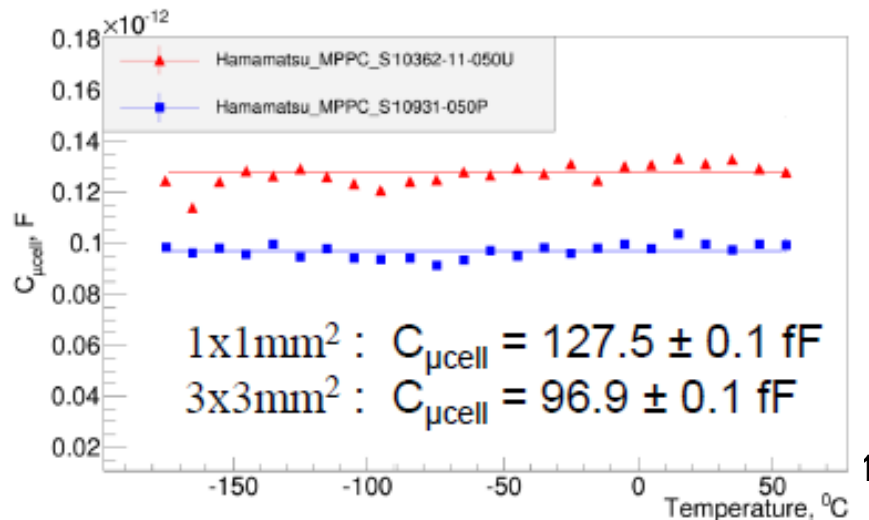
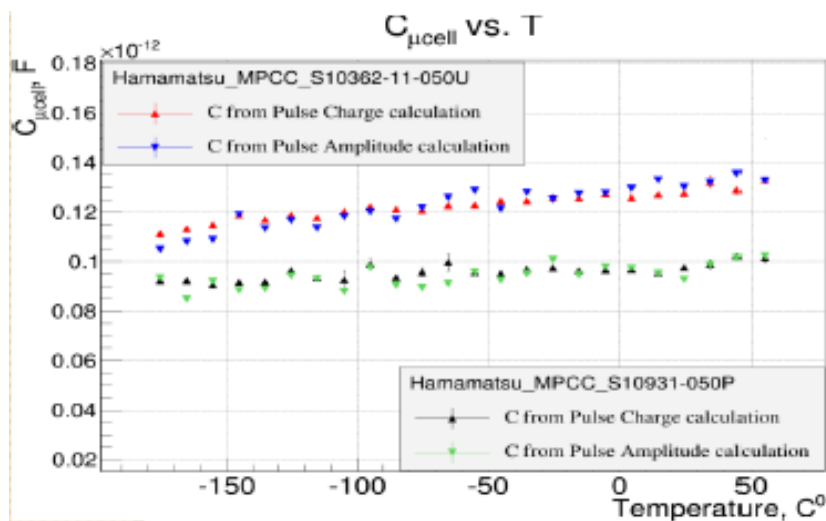
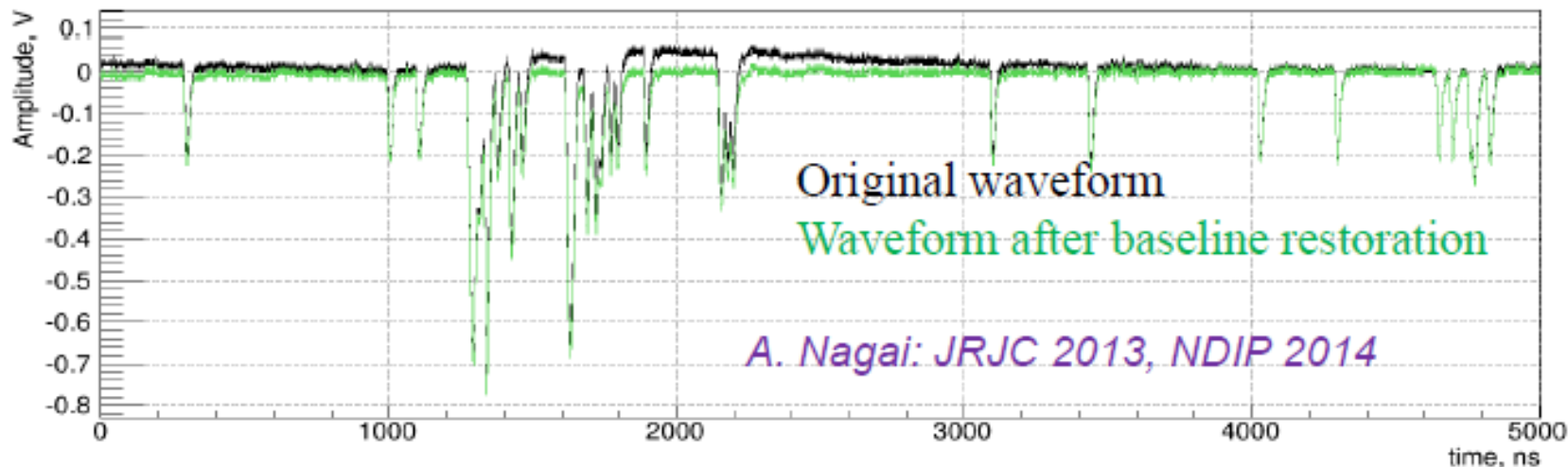
- $0.5 \times 0.5 \text{ mm}^2$
- $50 \times 50 \mu\text{m}^2$ cell size with trenches
- specifically designed for us to be received by the end of 2014



R&D on SiPM detectors (2)

- Development of a calibrated & automatic procedure for SiPM parameters analysis based on ROOT framework
 - collaboration with Fermilab (A. Para)
 - synergy with any physics experiment intending to use SiPM detectors

Waveform, Voltage : 72.08 V. Temperature : 55 C⁰



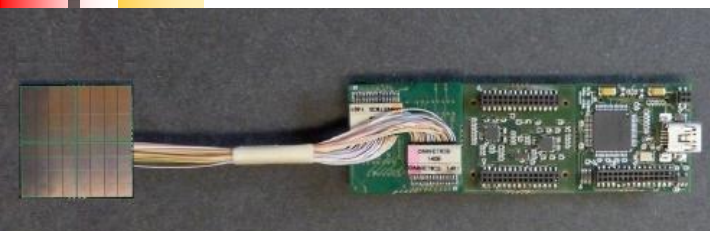
R&D on SiPM detectors (3)



• R&D on SiPM for LHCb SciFi Tracker

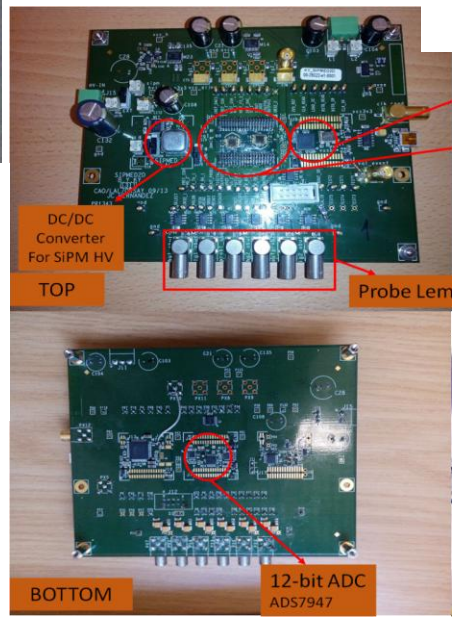
- Arrays of SiPM from Hamamatsu (Japan) and KETEK (Munich, Germany)
 - 1x128 SiPM's (32 x 2 mm²);
 - SiPM: 0.25 x 1.5 mm²; 100 (4 x 25) μ cells; μ cell: 57.6 x 62.5 μ m²
- Main requirements on SiPM characteristics
 - Small temperature dependence (i.e. $R_q \rightarrow$ signal shape, $V_{bd} \rightarrow G$)
 - Radiation hardness (DCR)
 - High PDE for broad wavelength range
 - T during experiment: -40°C
- Future R&D activity at LAL (work package SiPM LHCb):
 - Build a test-bench: cryocooler -200°C < T < +25°C + climatic chamber (SiPM) + readout acquisition system
 - Study of temperature dependence of SiPM parameters, before / after neutron irradiation of $\sim 10^{11}$ neqv (1 MeV)/mm²
 - Contacts with industrial partners: feedback and parameters improvements adapted for LHCb requirements

Development of miniaturized readout electronics



SONIM

SiPM arrays + readout electronics
(based on SIPMED 3D boards)



2D SONIM test board
Tests under progress

FPGA Cyclone3
2 EASIROC ASICs
2x32channels

8 switches to select
the input of the channel



TEST BENCH

*Thanks to SERDI technical contributions:
B. Ky, S. Conforti di Lorenzo, D. Breton, JC. Hernandez, P. Favre, B. Debennerot
CMS cabling and EASIROC wire bonding performed at CERN
EASIROC chip from Omega group, LLR*

Future development on miniaturized electronics:

- Multichannel readout electronics adapted for intra-operative beta imaging application (i.e. 64 channels, compact geometry, performances of single photon detection)
- Single channel readout electronics for preclinical application (counting and signal digitization, T control, wireless communication, stand alone power supply)